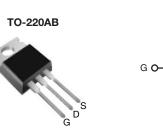
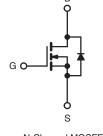


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	250				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.45				
Q _g (Max.) (nC)	41				
Q _{gs} (nC)	6.5				
Q _{gd} (nC)	22				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF634PbF
	SiHF634-E3
SnPb	IRF634
	SiHF634

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	250	V	
Gate-Source Voltage			V _{GS}	± 20	V	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	1-	8.1		
	VGS AL TO V	$T_C = 100 \ ^\circ C$	ID	5.1	А	
Pulsed Drain Current ^a			I _{DM}	32		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	300	mJ	
Repetitive Avalanche Current ^a			I _{AR}	8.1	A	
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	74	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.8	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150		
Soldering Recommendations (Peak Temperature)	for	10 s	-	300 ^d	- °C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 7.3 mH, $R_g = 25 \Omega$, $I_{AS} = 8.1 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 8.1$ A, dI/dt ≤ 120 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62 - 1.7				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50				°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-						
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		•				•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 2	50 µA	250	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	I _D = 1 mA	-	0.37	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	_{GS} , I _D = 2	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _G	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		V _{DS} = 250 V, V _{GS} = 0 V		-	-	25		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 200 V, V	/ _{GS} = 0 V,	T _J = 125 °C	-	-	250	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	١ _c	_o = 5.1 A ^b	-	-	0.45	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 5	0 V, I _D =	5.1 A ^b	1.6	-	-	S
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	770	-	pF	
Output Capacitance	C _{oss}			-	190	-		
Reverse Transfer Capacitance	C _{rss}			-	52	-		
Total Gate Charge	Qg				-	-	41	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 5.6 \text{ A}, V_{DS} = 200 \text{ V},$ see fig. 6 and 13 ^b		-	-	6.5	nC
Gate-Drain Charge	Q _{gd}		3001	ig. 6 and 16	-	-	22	1
Turn-On Delay Time	t _{d(on)}				-	9.6	-	1
Rise Time	t _r	V_{DD} = 125 V, I _D = 5.6 A, R _g = 12 Ω, R _D = 22 Ω, see fig. 10 ^b		-	21	-	- ns	
Turn-Off Delay Time	t _{d(off)}			-	42	-		
Fall Time	t _f			-	19	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	n	
Internal Source Inductance	Ls			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8.1	А	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	32		
Body Diode Voltage	V_{SD}	$T_{J} = 25 \ ^{\circ}C, \ I_{S} = 8.1 \ A, \ V_{GS} = 0 \ V^{b}$		-	-	2.0	V	
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C I	560 41/	dt - 100 A (upb	-	220	440	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 5.6 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$		-	1.2	2.4	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn	-on time i	s negligible (turn	-on is do	minated b	by L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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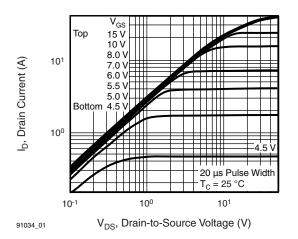


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

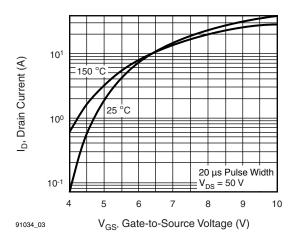


Fig. 3 - Typical Transfer Characteristics

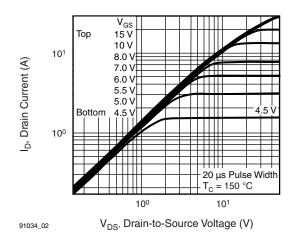


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

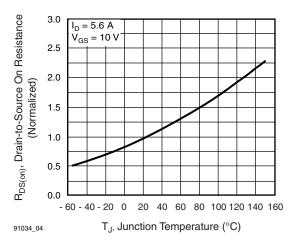


Fig. 4 - Normalized On-Resistance vs. Temperature

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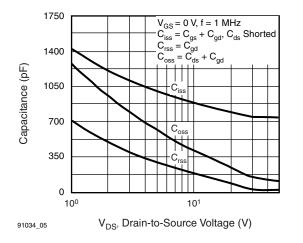
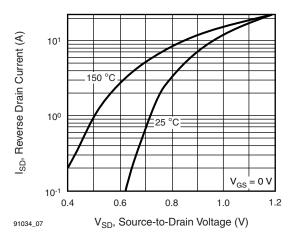


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





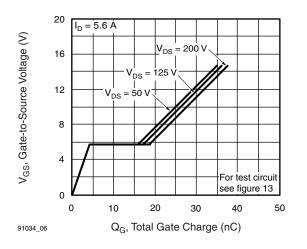


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

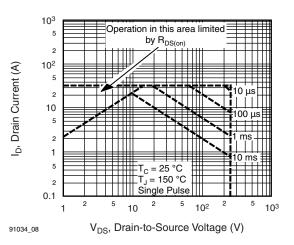


Fig. 8 - Maximum Safe Operating Area

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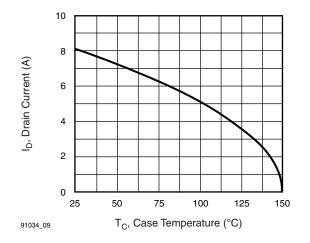


Fig. 9 - Maximum Drain Current vs. Case Temperature

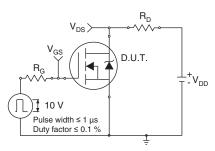


Fig. 10a - Switching Time Test Circuit

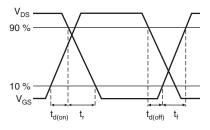


Fig. 10b - Switching Time Waveforms

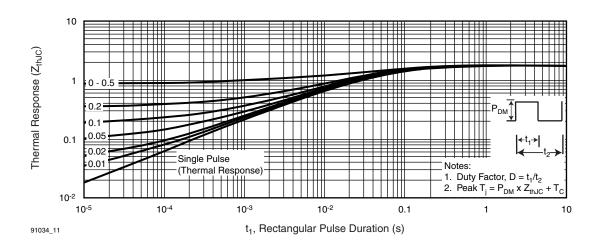


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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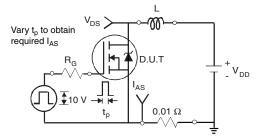


Fig. 12a - Unclamped Inductive Test Circuit

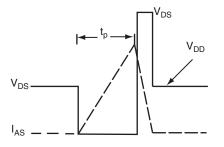
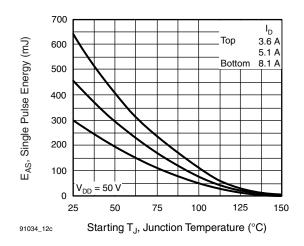
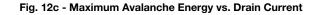


Fig. 12b - Unclamped Inductive Waveforms





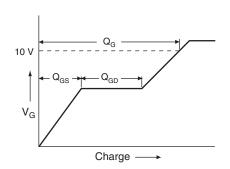


Fig. 13a - Basic Gate Charge Waveform

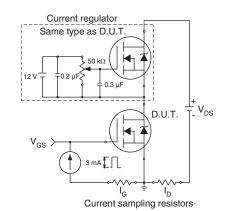
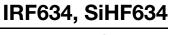


Fig. 13b - Gate Charge Test Circuit

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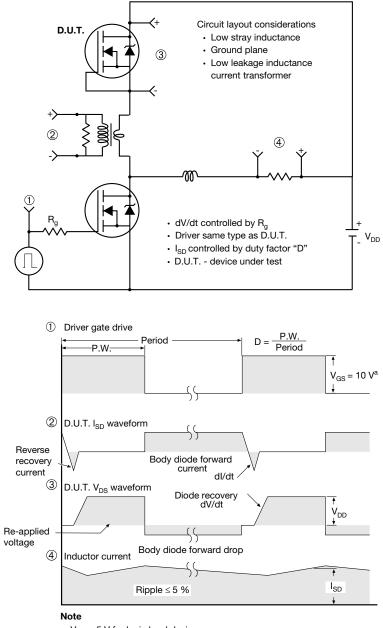
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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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